

Electronics for Physicists

Analog Electronics

Chapter 8; Lecture 15

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Chapter 8

Additional Topics

- Filters and Voltage Regulators
- Noise

Overview

1. Basics
2. Circuits with R, C, L with Alternating Current
3. Diodes
4. Operational Amplifiers
5. Transistors - Basics
6. 2-Transistor Circuits
7. Field Effect Transistors
8. **Additional Topics**
 - Filters
 - Voltage Regulators
 - Noise

Noise

In: Chapter 8 - Additional Topics

- From a detector perspective

Based on H. Spieler, N. Wermes

- Distinguish different types of noise:

- Signal noise (better: signal fluctuations)
- Electronic noise

inherent to a system

- EMI (electromagnetic interference)
RFI (radio frequency interference)
“pick-up noise”

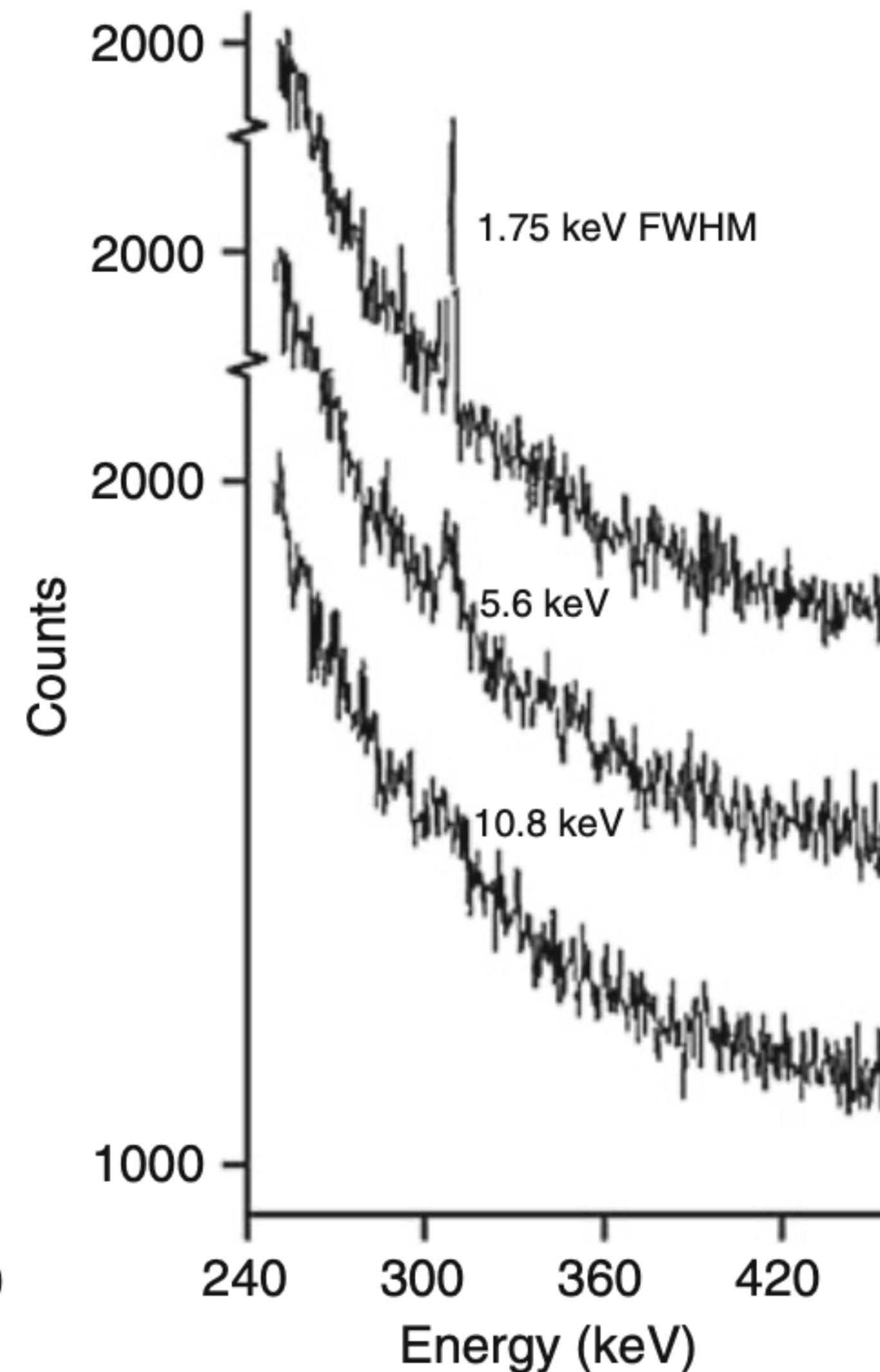
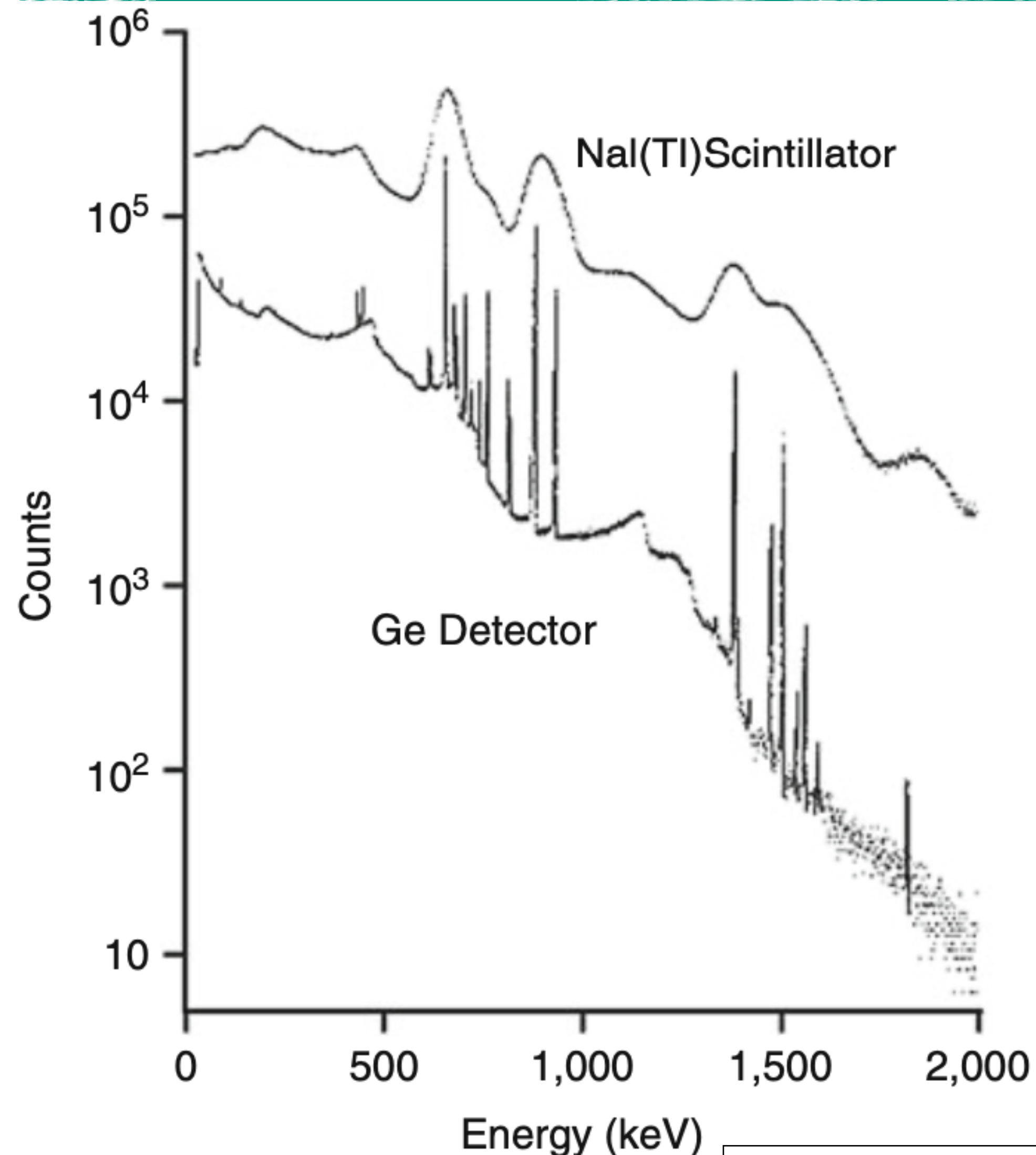
introduced externally

different for every system - often
depends on (changing) external
conditions

Often: common-mode noise

Why should you care?

Effect on detector signals



Lower noise improves:

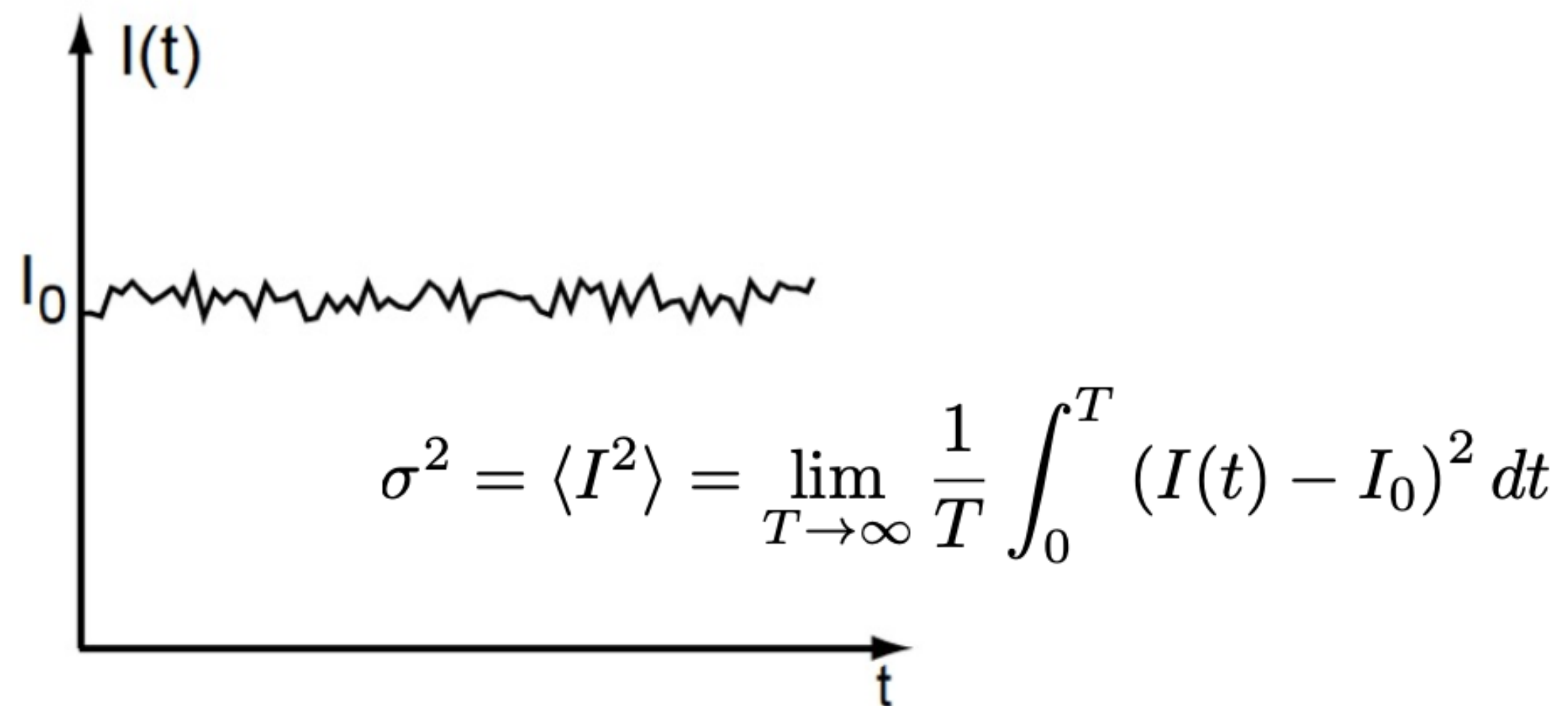
- resolution and ability to distinguish signals
- signal-to-noise ratio

Aus: H. Spieler, in I. Fleck et al. (eds.), Handbook of Particle Detection and Imaging, Springer (2020)

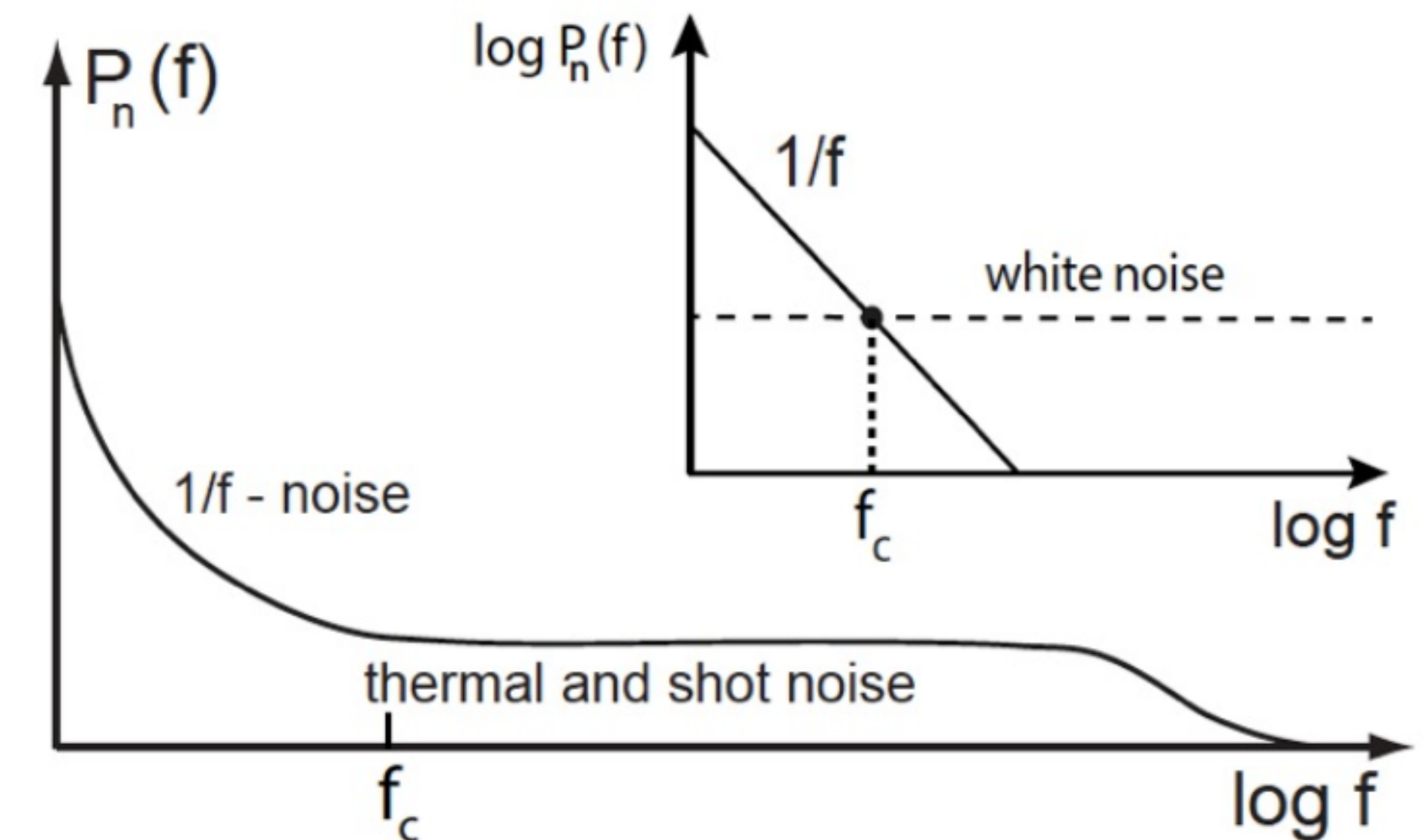
Quantifying Noise

Variation around a mean value

- Noise is a variation around a mean value
=> integral over extended period = 0, characterized by variance
Current variation $\langle i^2 \rangle$, voltage variation $\langle v^2 \rangle$



(a) Current noise as a function of time.



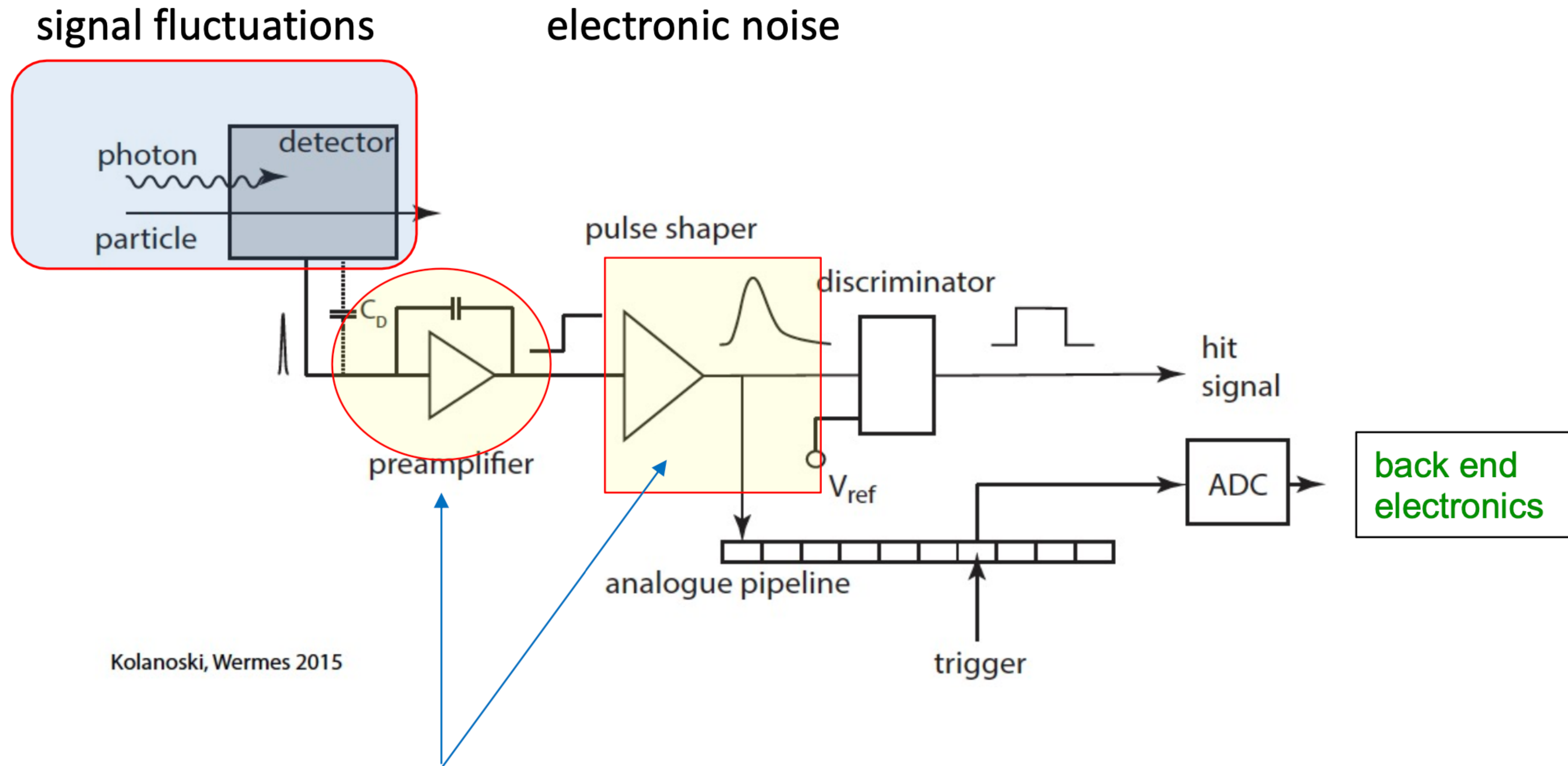
(b) Spectral noise density (schematic) as a function of frequency.

spectral noise power density:

$$\frac{dP_n}{df} = \frac{1}{R} \frac{d\langle v^2 \rangle}{df} = R \frac{d\langle i^2 \rangle}{df}$$



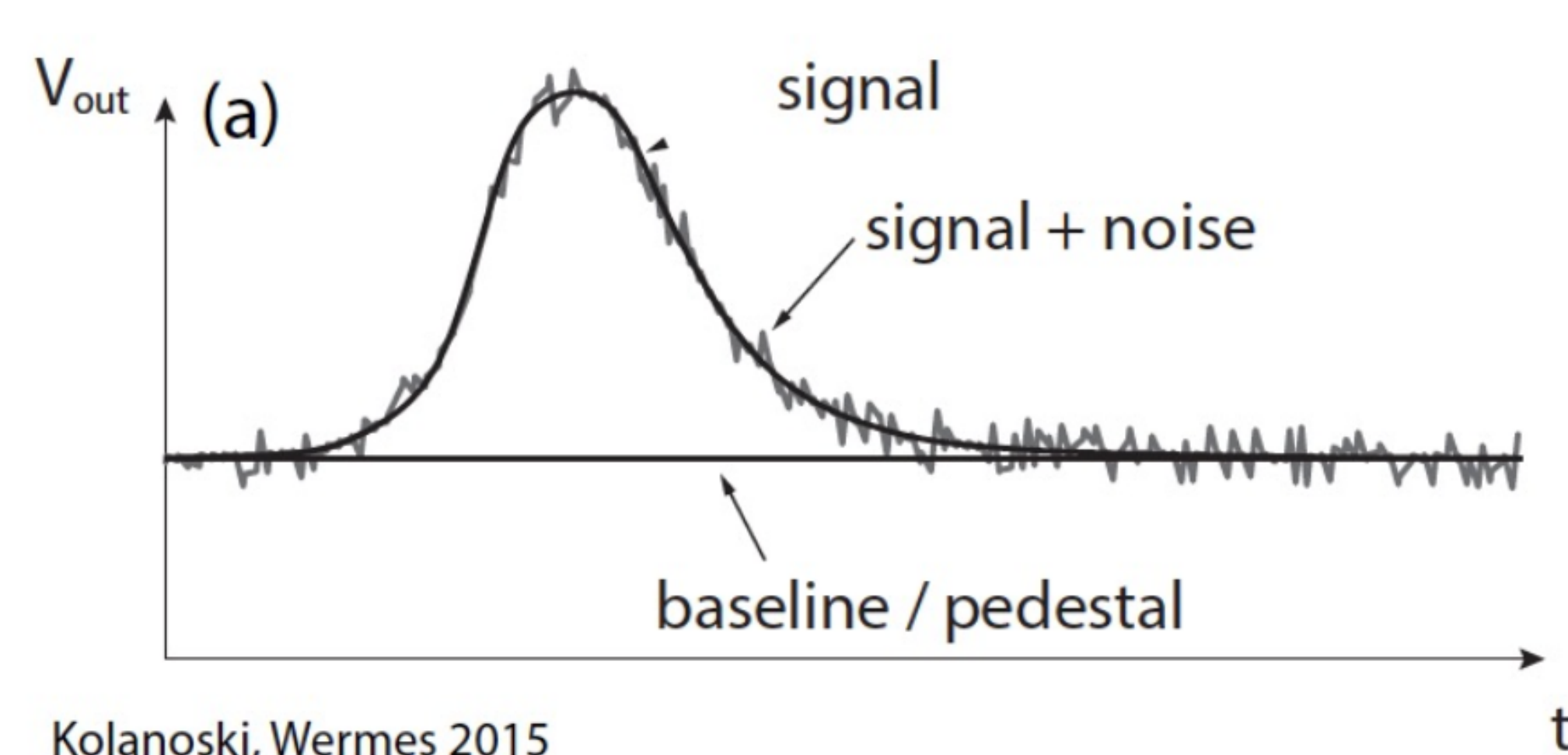
$$P_n = \int_0^\infty \frac{dP_n}{df} df$$



The dominant electronic noise of a system is hidden in these parts

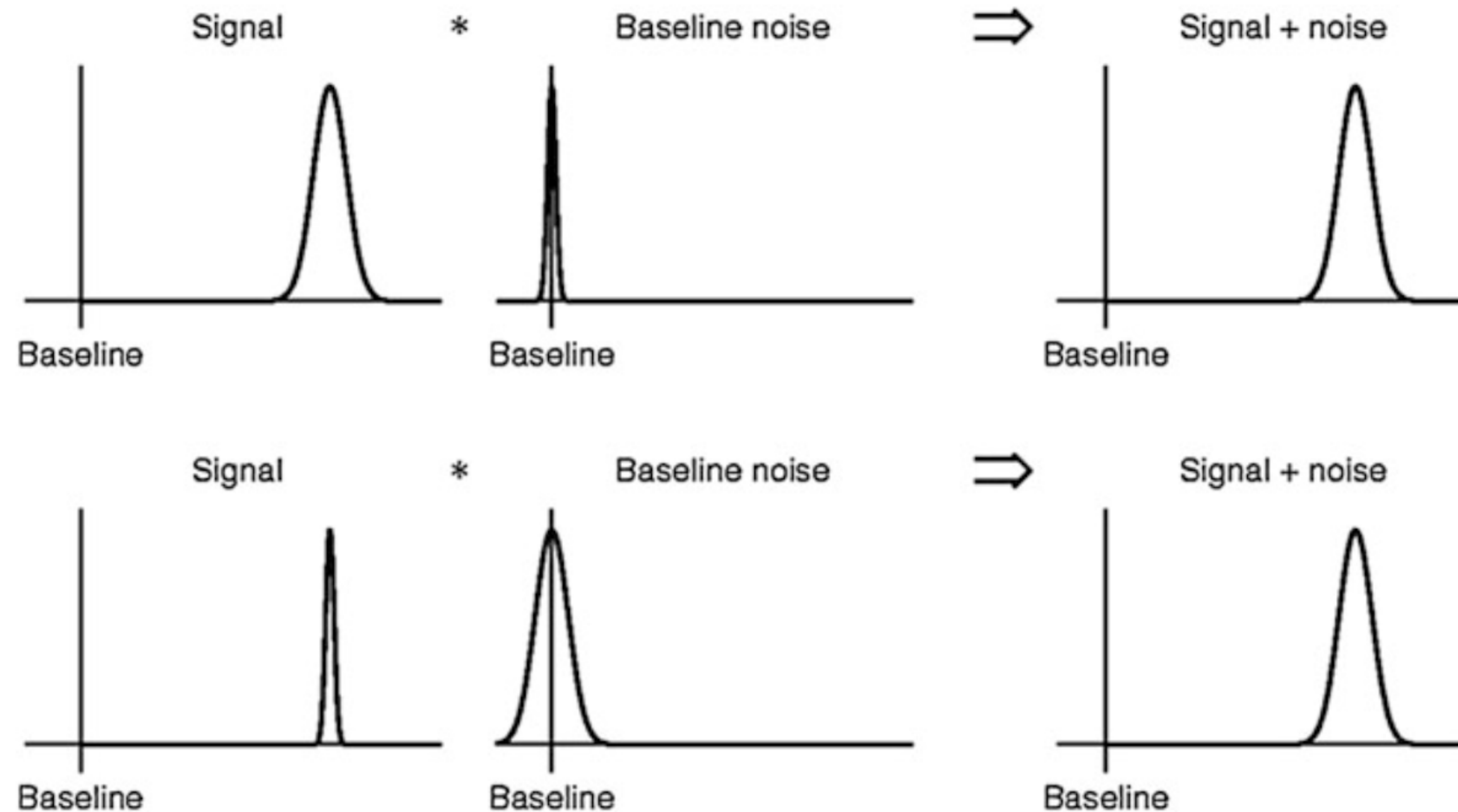
Signal Fluctuations and Electronic Noise

Scenarios



Kolanoski, Wermes 2015

example: scintillator with SiPM / PMT readout



example: silicon detector

Aus: H. Spieler, in I. Fleck et al. (eds.), Handbook of Particle Detection and Imaging, Springer (2020)

A current

$$i = \frac{Nev}{d}$$

can fluctuate in **number**

and in **velocity**

- fluctuations in carrier emission over a barrier
- fluctuations in trap / release processes

$$(di)^2 = \left(\frac{ev}{d} dN \right)^2 + \left(\frac{eN}{d} dv \right)^2$$

- Brownian motion (thermal)

- Originates from thermal motion of charge carriers:
Introduces current fluctuations (and with that voltage fluctuations via a resistor)

Thermal power in equilibrium described by Planck's law:

$$\frac{dP}{d\nu} = \frac{h\nu}{\exp\left(\frac{h\nu}{kT}\right) - 1} \rightarrow (\text{for } h\nu \ll kT) = \frac{h\nu}{1 + \frac{h\nu}{kT} - 1} = kT$$

=> Power in a frequency interval Δf independent of f : $P = kT \Delta f$ "white noise"

Thermal noise in a resistor:



Power from voltage generated by R_1 on R_2 : $P_{1-2} = v^2/R$

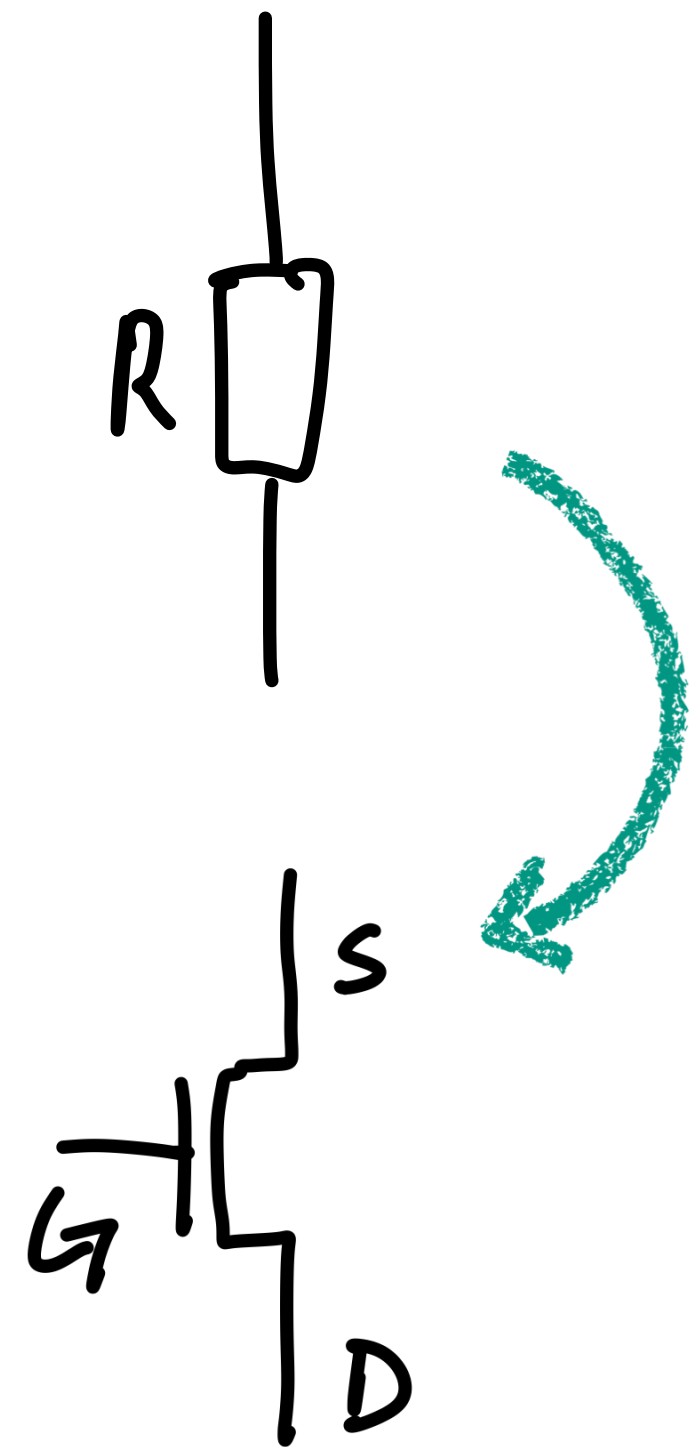
Voltage given by thermal fluctuations $\langle v_1^2 \rangle$:

$$P = \frac{\langle v_1^2 \rangle}{4R} \Rightarrow d\langle v_n^2 \rangle = 4kTR df \quad d\langle i_n^2 \rangle = \frac{4kT}{R} df$$

Numeric example: 1 k Ω Resistor: $\sqrt{\frac{d\langle i^2 \rangle}{df}} = 4 \frac{\text{pA}}{\sqrt{\text{Hz}}}$ or $\sqrt{\frac{d\langle v^2 \rangle}{df}} = 4 \frac{\text{nV}}{\sqrt{\text{Hz}}}$

Thermal Noise

Example of a MOSFET

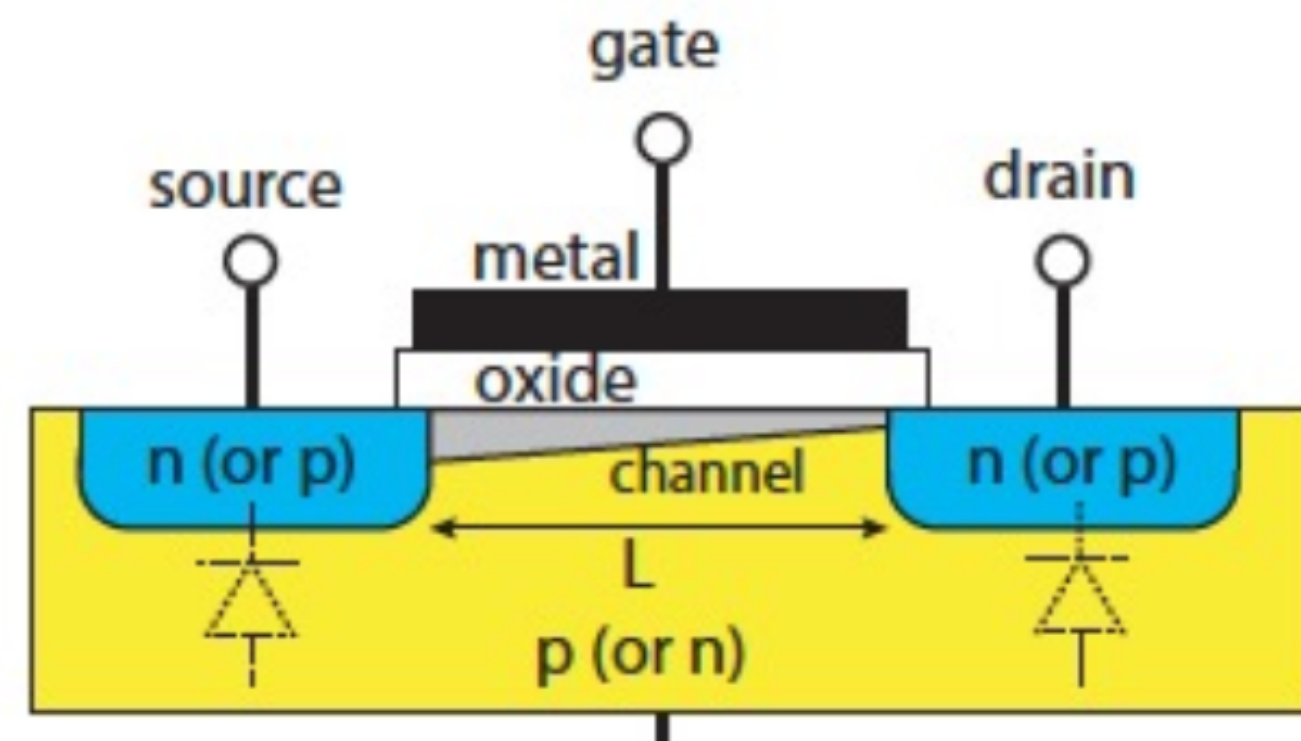


$$d\langle v_n^2 \rangle = 4 kT R df$$

$$d\langle i_n^2 \rangle = \frac{4 kT}{R} df$$

$$d\langle v_n^2 \rangle = 4 kT \gamma \frac{1}{g_m} df$$

$$d\langle i_n^2 \rangle = 4 kT \gamma g_m df$$



$$g_m = \frac{dI_{DS}}{dU_{GS}}$$

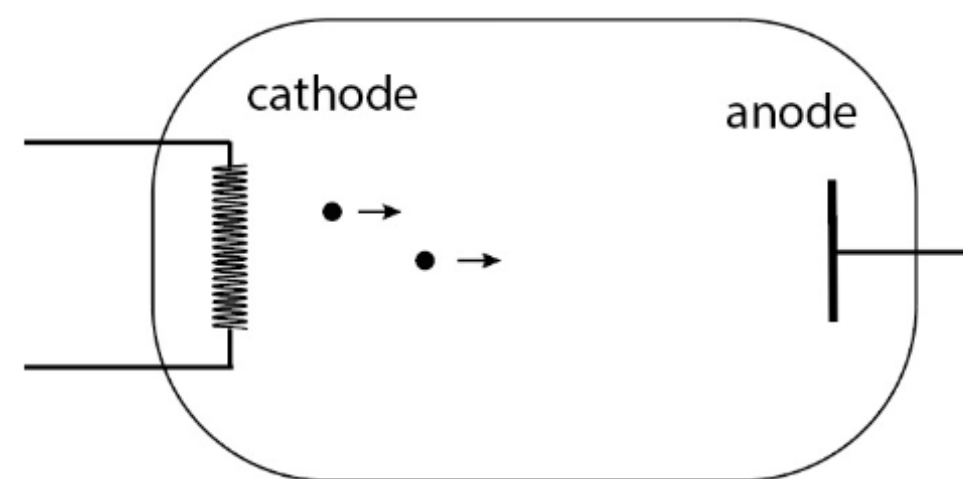
(transconductance)

γ : adjustment factor:
2/3 in strong inversion
1/3 in weak inversion

- Origin: Fluctuation of charge carrier injection in a device when quantisation plays a role

NB: Over a barrier - NOT present in ohmic resistor

Classic example:
vacuum tube



Applies equally to pn-boundaries (diodes, solid state detectors,...)
e/h in depletion zone induce *current pulses* until recombination

=> current pulses = δ functions - all frequencies contribute: white noise

$$\int_{-\infty}^{+\infty} i_e(t) dt = e \quad \Rightarrow di_e / df = 2e \quad (\text{convention } 0 < f < \infty \rightarrow -\infty < f < \infty)$$

with this: noise term $\sqrt{\frac{d \langle i_e^2 \rangle}{df}} = \sqrt{2}e$ for infinitely narrow frequency slice df

=> For a current with N electrons: average current $I = Ne/t = Ne \Delta f$

$$\langle i^2 \rangle = \sum_{k=1}^N \left(\frac{d_{i,k}}{df} \right)^2 (df)^2 = 2Ne^2(df)^2 = 2e \underbrace{(Ne df)}_{\langle i \rangle} df = 2e \langle i \rangle df$$

Numeric example:

1 mA current:

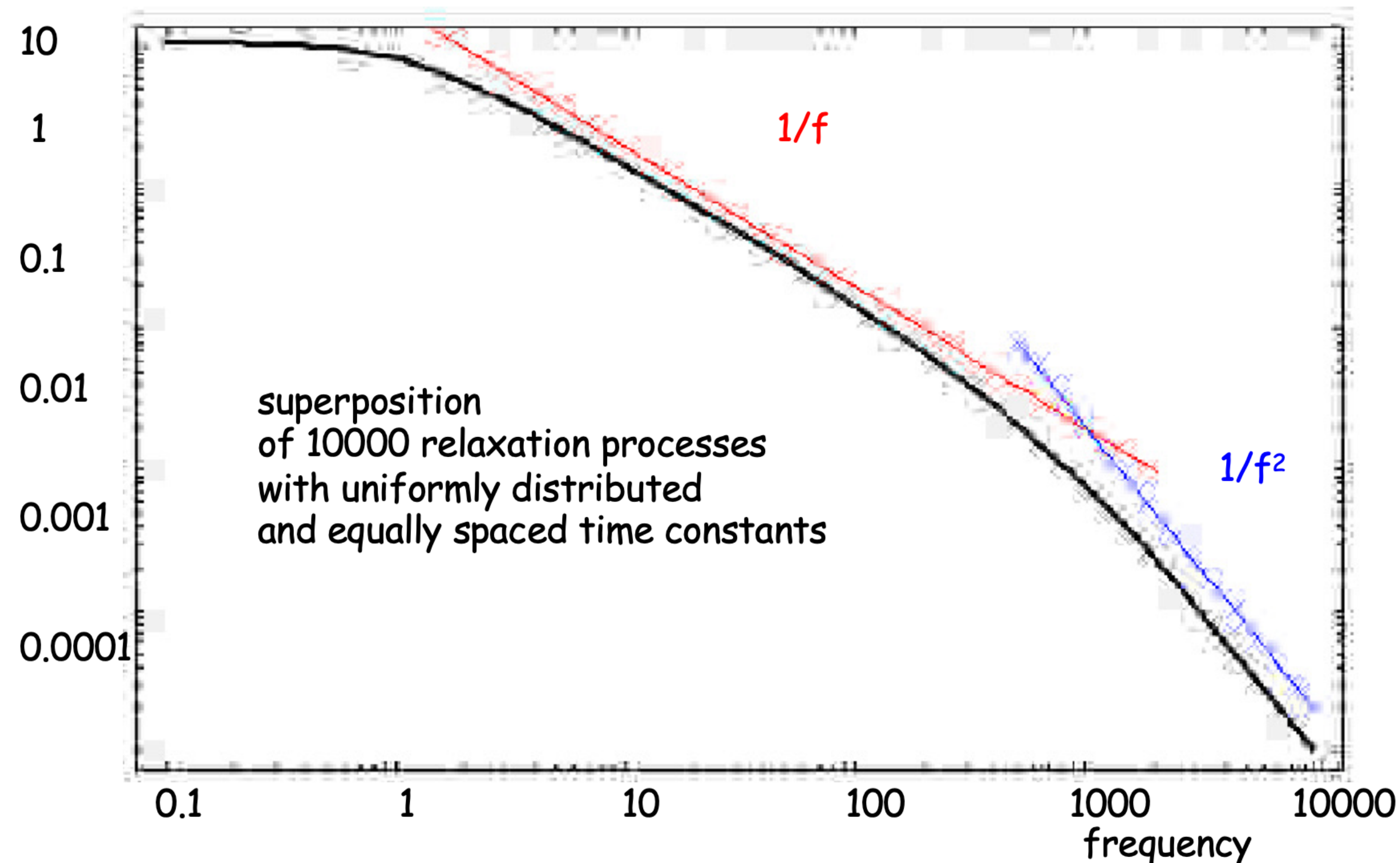
$$\sqrt{\frac{\Delta \langle i^2 \rangle}{\Delta f}} = \sqrt{2e I_0} = 18 \frac{\text{pA}}{\sqrt{\text{Hz}}}$$

needs current !

- Wide range of different sources - generally from a superposition of relaxation processes with different time constants.

Results in a power spectrum that scales with $1/f$ (a power of f):

spectral density

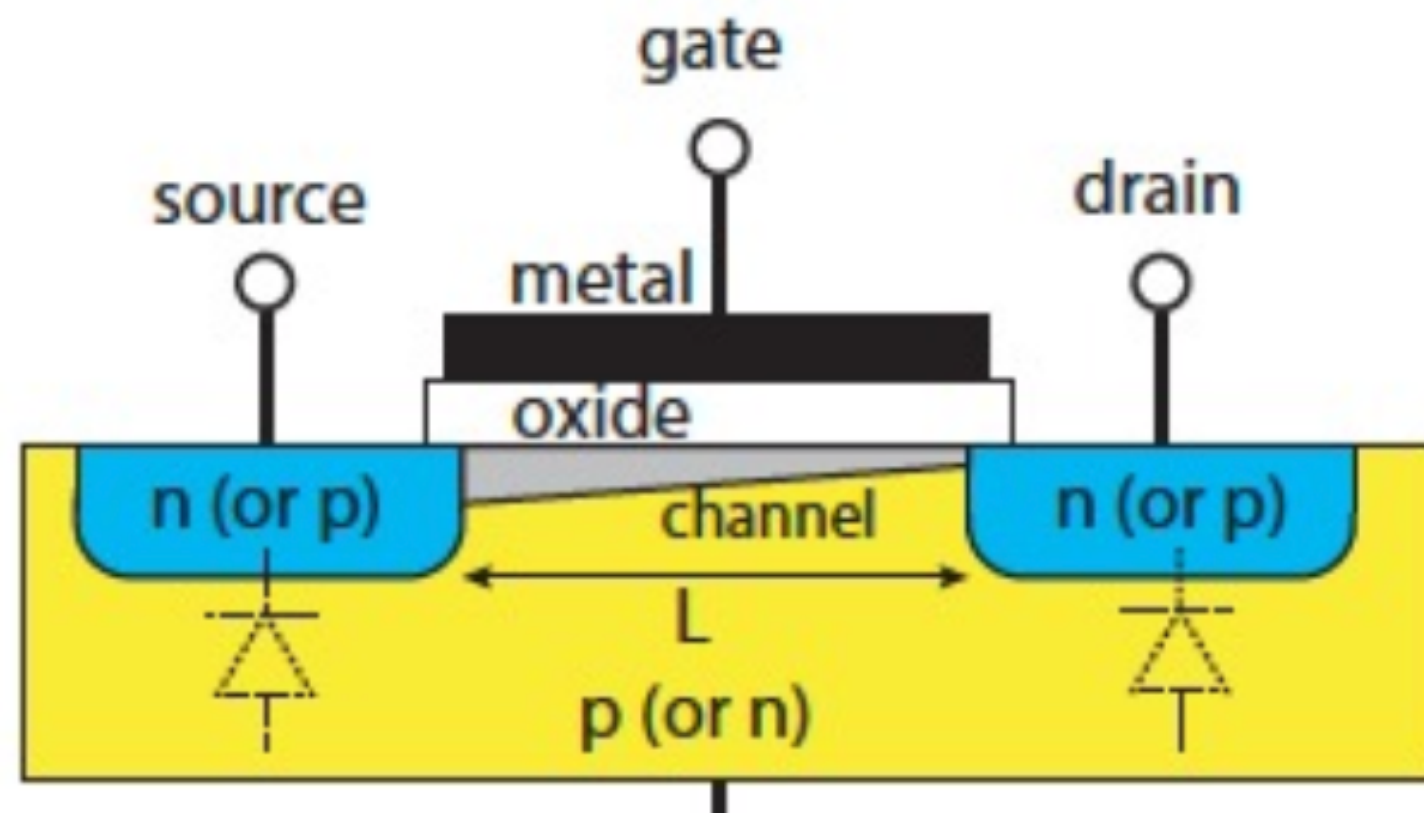


“pink noise”

[arXiv:physics/0204033](https://arxiv.org/abs/physics/0204033)

1/f Noise

Example: MOSFET



- Originates from trapping and release of charges in gate oxide
- depends on gate area $A = W \times L$

$$\frac{d \langle v_{1/f}^2 \rangle}{df} = K_f \frac{1}{C'_{ox} W L} \frac{1}{f}$$

empirical parametrisation (e.g. PSPICE)

$$C'_{ox} = \frac{3}{2} \frac{C_{GS}}{WL} \approx \epsilon_0 \epsilon / d$$

$$K_f^{\text{NMOS}} \approx 30 \times 10^{-25} \text{ J}, K_f^{\text{PMOS}} \approx 0.05-0.1 \times K_f^{\text{NMOS}}$$

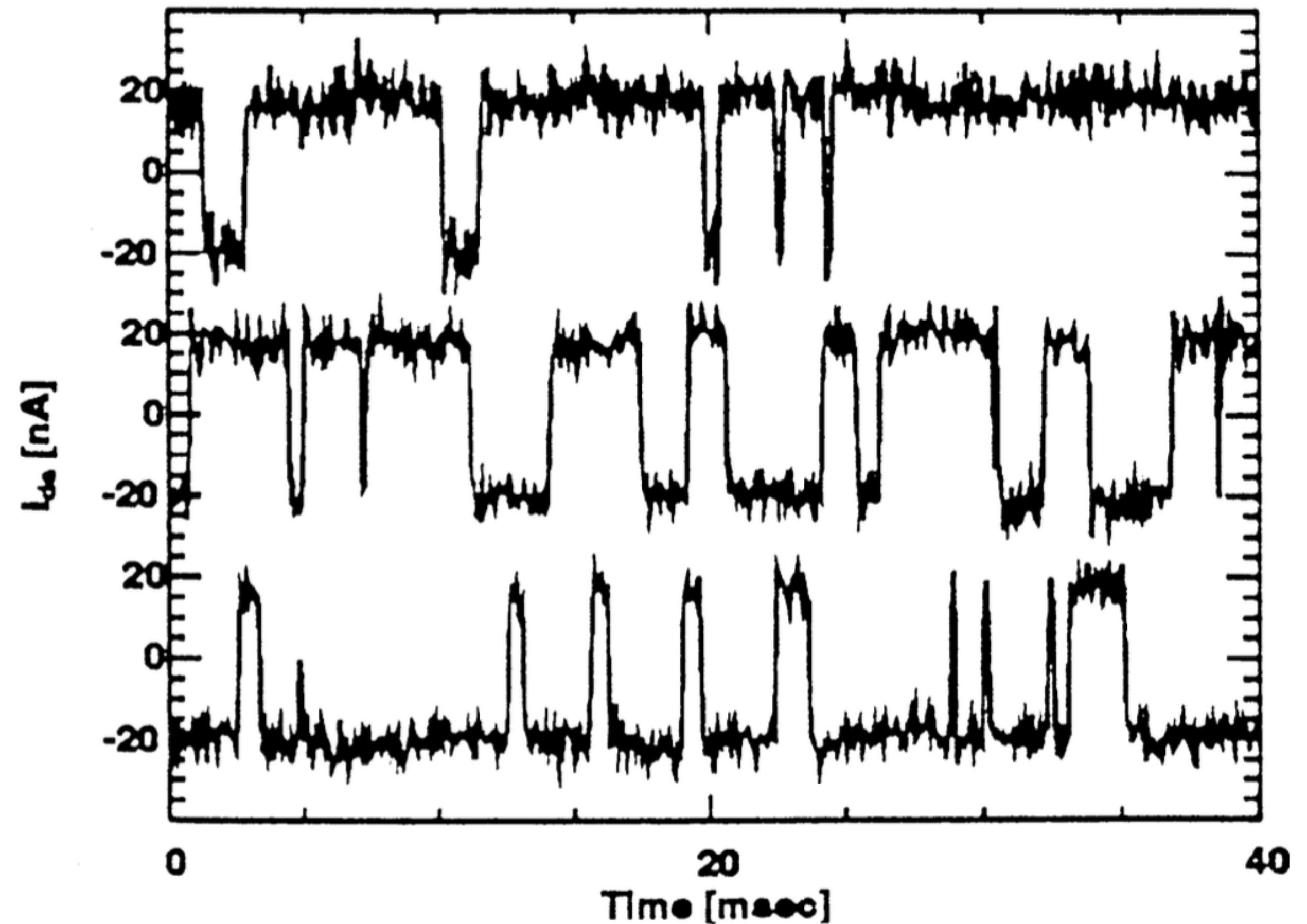
- One source of $1/f$ noise

RTS noise: Random Telegraph Signal noise
also: “burst noise”, “popcorn noise”

Usually related to trapping/detrapping processes.

Superposition of several different processes with different trapping time results in a $1/f$ contribution.

Typically low frequency: Hard to filter out, can be a significant challenge for low-noise devices.



Noise Sources - Summary

Three main drivers

$$\langle i^2 \rangle = \frac{4 kT}{R} df$$

thermal fluctuations (Brownian motion)

velocity fluctuations

$$\langle i^2 \rangle = 2e \langle i \rangle df$$

fluctuations in hopping over a barrier (shot)

number fluctuations

$$\langle i^2 \rangle = \text{const} \frac{1}{f^\alpha} df$$

trap/release fluctuations of carriers

number fluctuations

thermal noise

(in resistors, transistor channels)

shot noise

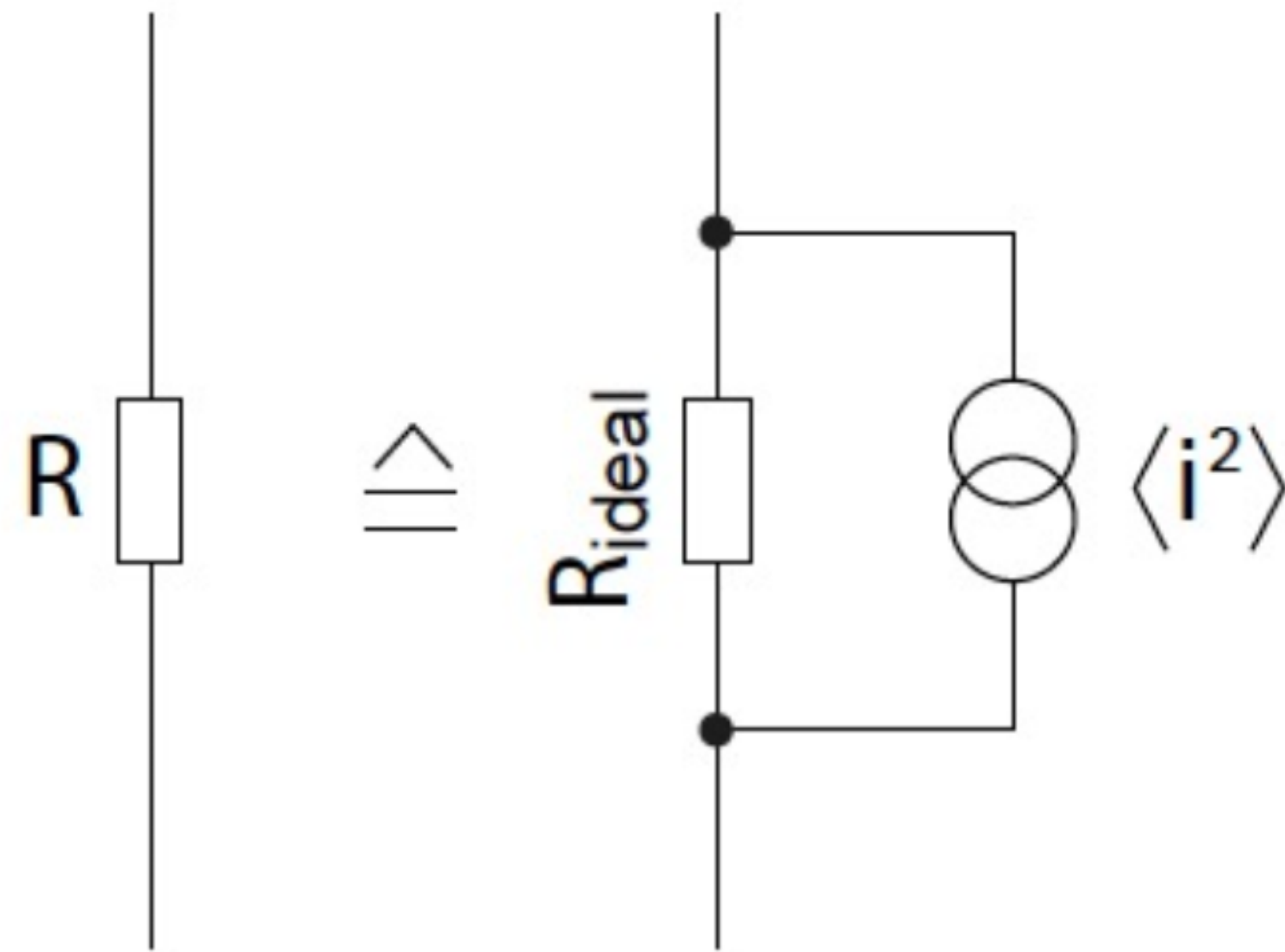
(where currents due to barrier crossings appear, e.g. in diodes, NOT in resistors)

1/f noise

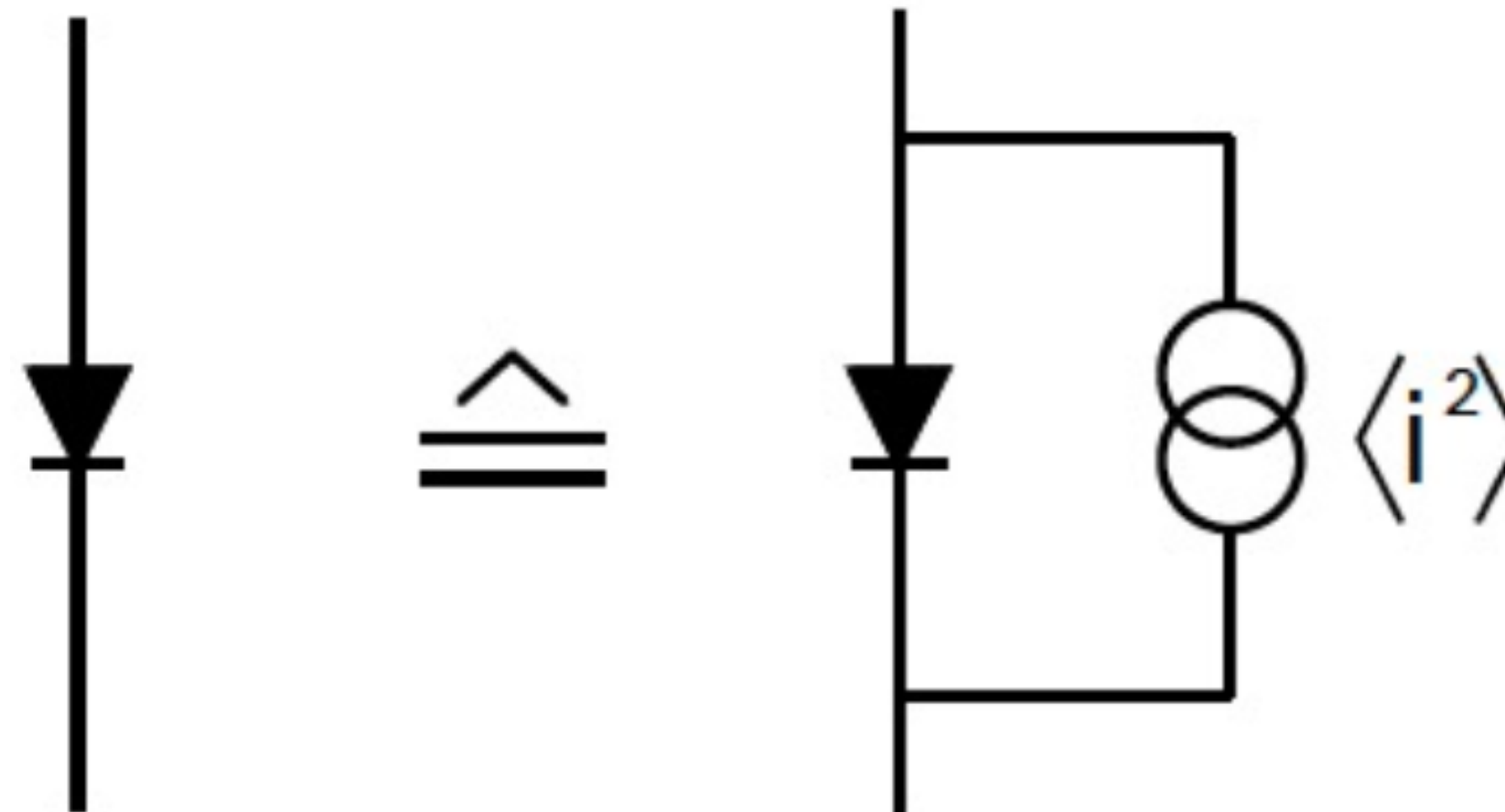
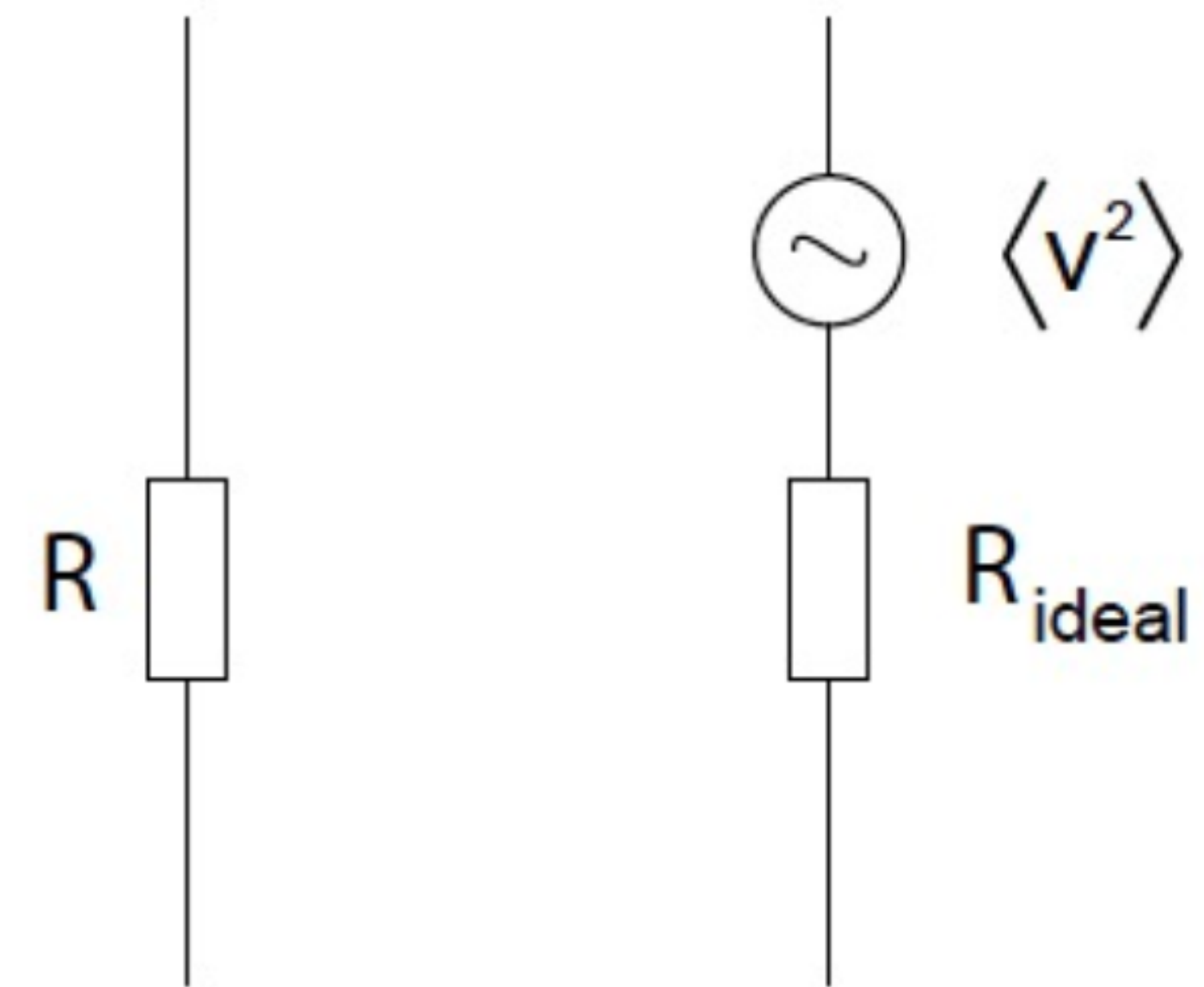
(whenever trapping occurs,
e.g. in (MOS) transistor channels)

Describing Noisy Circuit Elements

Replacement Circuits

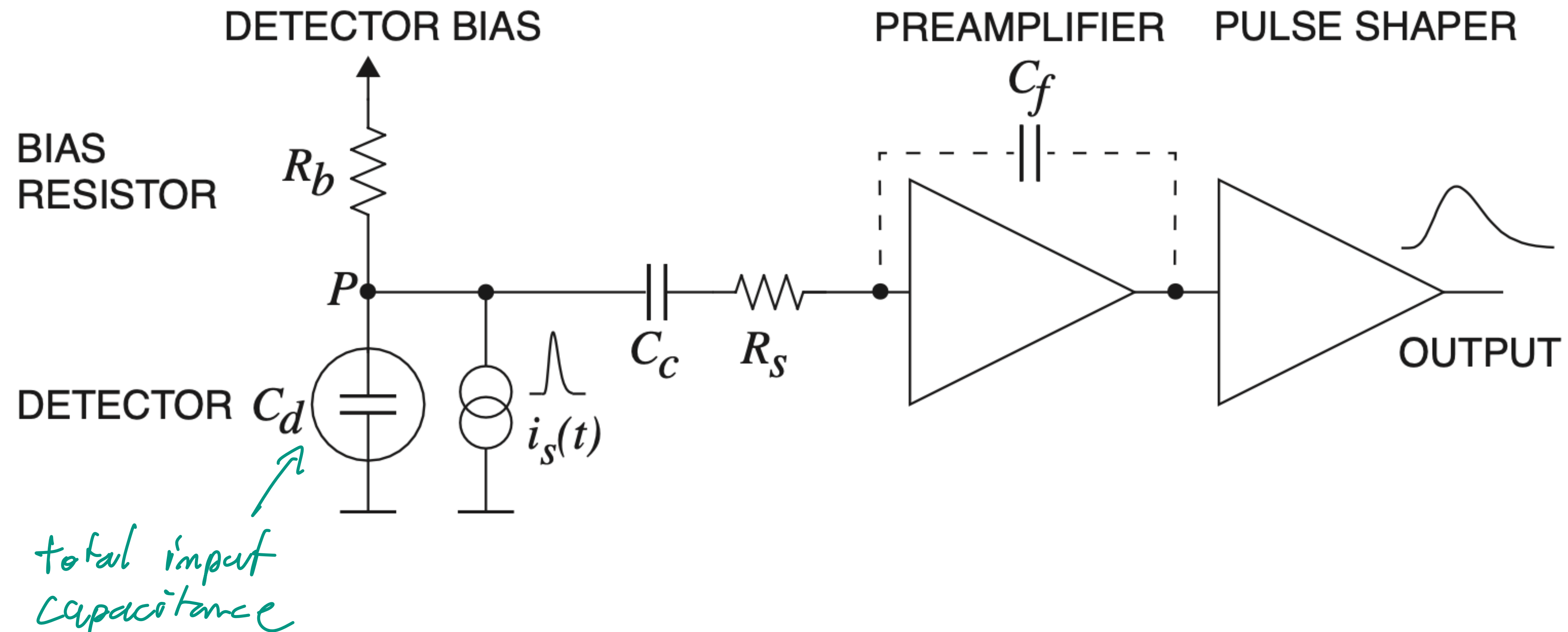


current
or
voltage



Which Noise Source Contributes Where?

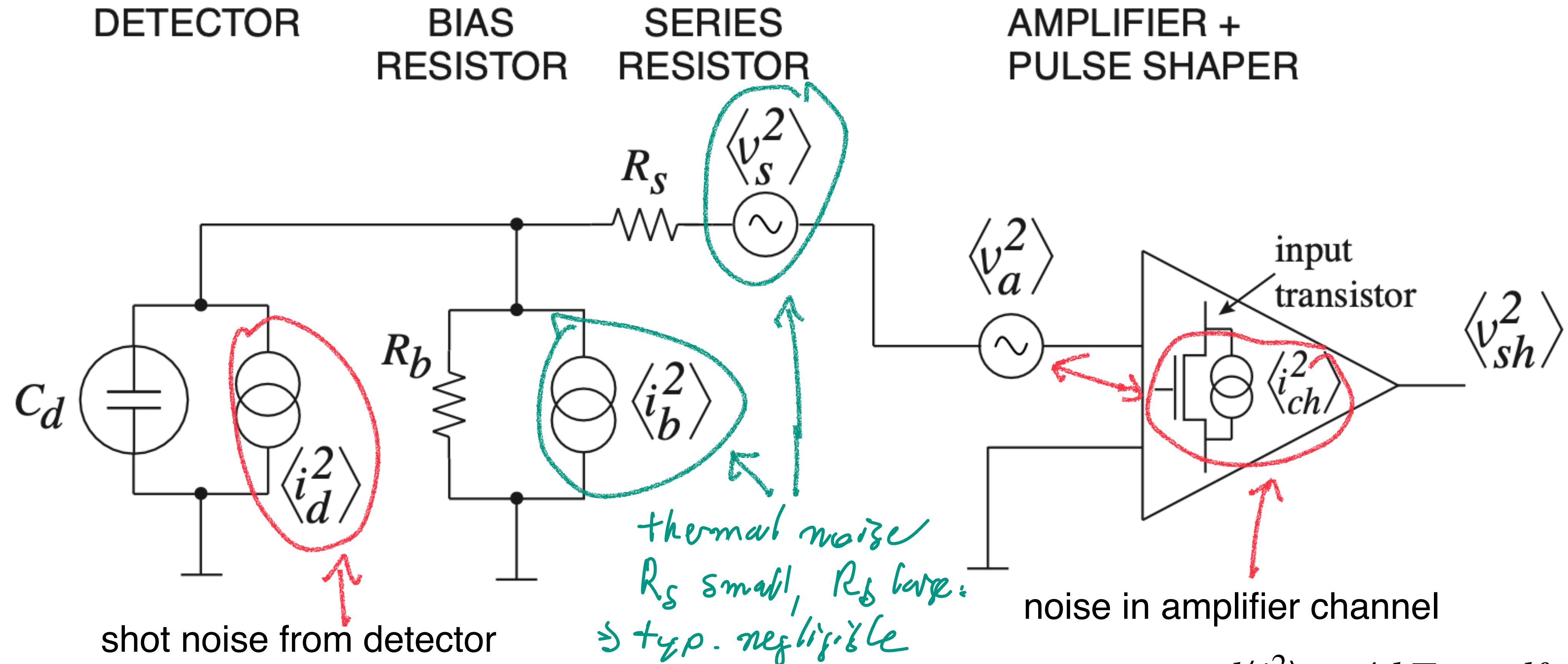
Back to the Detectors



from: R.L. Workman et al. (Particle Data Group), Prog. Theor. Exp. Phys. 2022, 083C01 (2022)

Which Noise Source Contributes Where?

Replacement diagram for noise analysis



shot noise from detector
(leakage) current

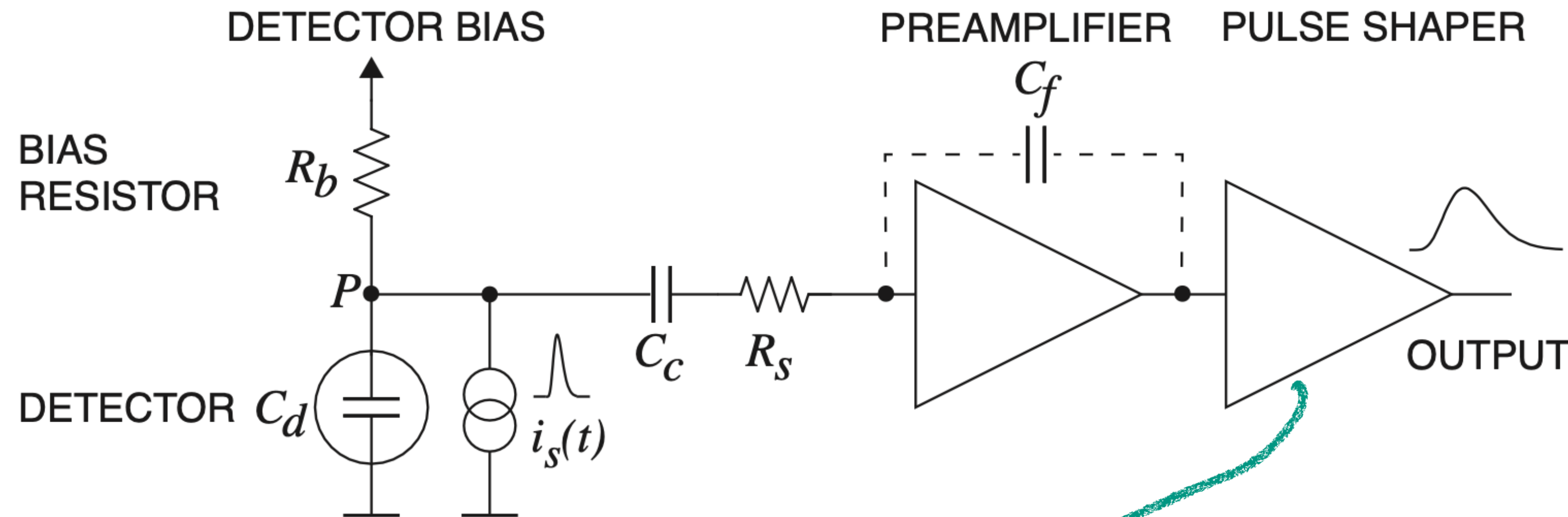
$$d\langle i_d^2 \rangle = 2e I_d df$$

thermal $d\langle i^2 \rangle = 4kT\gamma g_m df$

1/f $d\langle i^2 \rangle = K_\alpha \frac{1}{f^\alpha} df$

from: R.L. Workman et al. (Particle Data Group), Prog. Theor. Exp. Phys. 2022, 083C01 (2022)

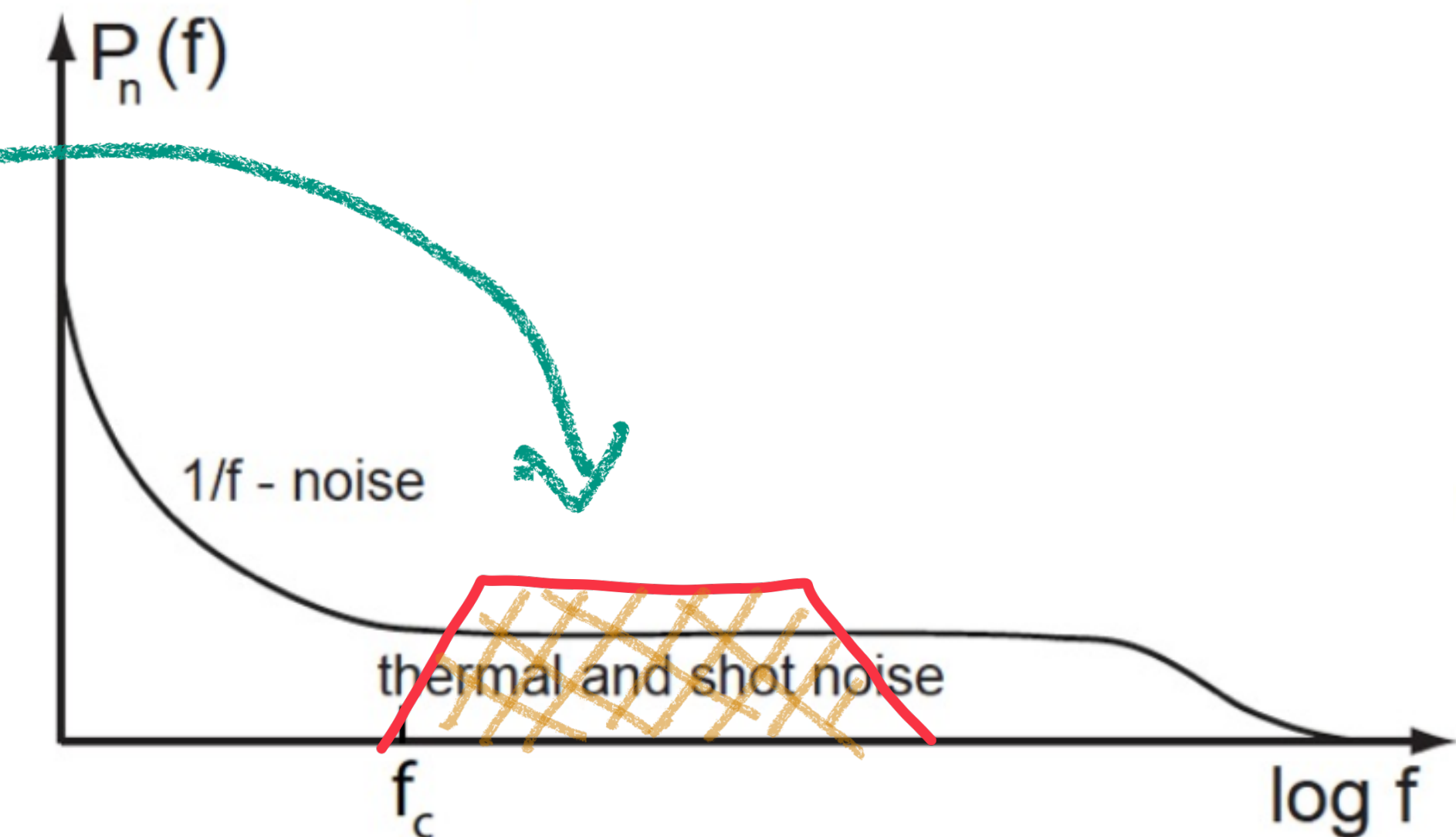
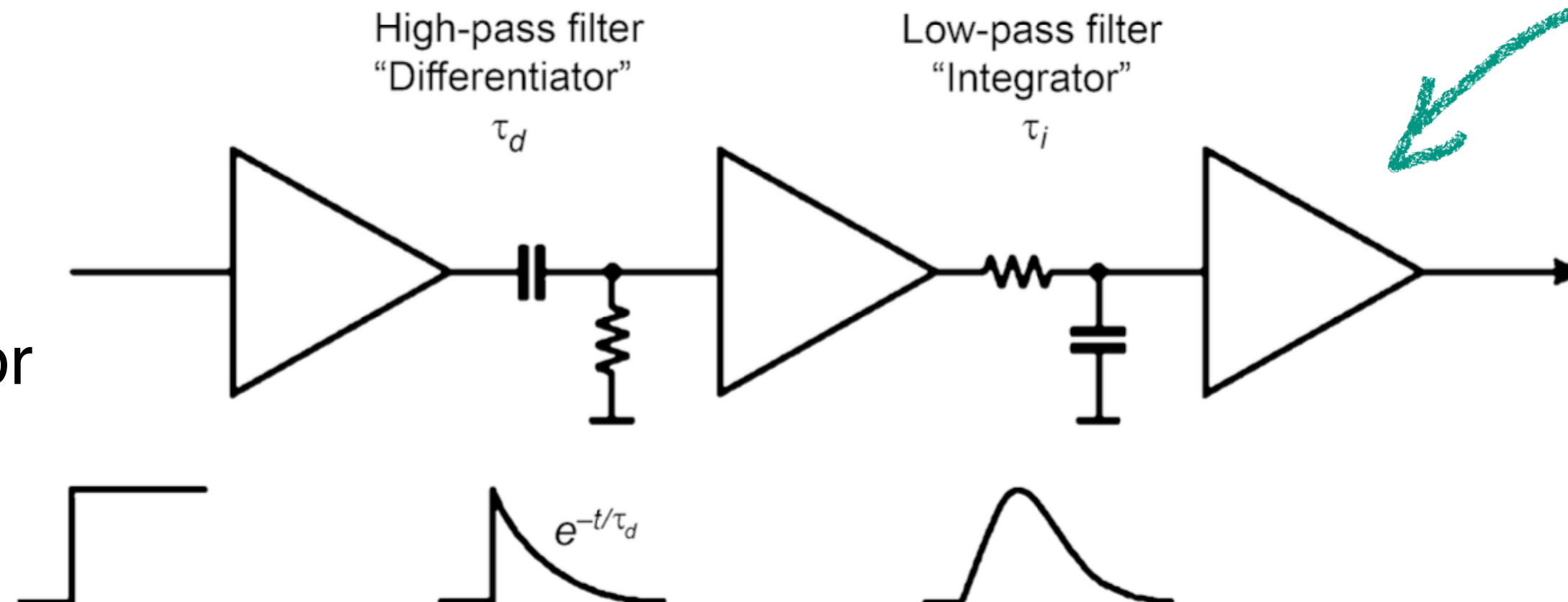
How Filters Influence Noise Effects



Shaper: A Bandpass
shaping time τ
(larger τ = smaller bandwidth)

Simple shaper: CRRC

from preamp:
current integrator



Equivalent Noise Charge

Quantifying Detector System Noise

- Understanding the noise performance of a system: Expressing the noise in signal units
“How many electrons as signal would produce the noise voltage output behind the shaper?”

$$\text{ENC} = \frac{\text{noise output voltage [V]}}{\text{output signal of a signal of } 1 \text{ } e^- \text{ [V/} e^- \text{]}}$$

$$\text{ENC}^2 = \frac{\langle v_{sh}^2 \rangle}{v_{sig}^2}$$

$$\text{ENC}^2 (e^{-2}) = \frac{(2.71)^2}{4e^2} \left(eI_d\tau + 2C_D^2 K_f \frac{1}{C'_{ox}WL} + \gamma \frac{2kT}{g_m} \frac{C_D^2}{\tau} \right) \quad [\text{w/o derivation}]$$

$$= a_{\text{shot}} \tau + a_{1/f} C_D^2 + a_{\text{therm}} \frac{C_D^2}{\tau},$$

$$\text{ENC}^2 (e^{-2}) = 11 \frac{I_d}{\text{nA}} \frac{\tau}{\text{ns}} + 740 \frac{1}{WL/(\mu\text{m}^2)} \frac{C_D^2}{(100 \text{ fF})^2} + 4000 \frac{1}{g_m/\text{mS}} \frac{C_D^2}{\tau/\text{ns}} \frac{(100 \text{ fF})^2}{\tau/\text{ns}}$$

Handwritten annotations:

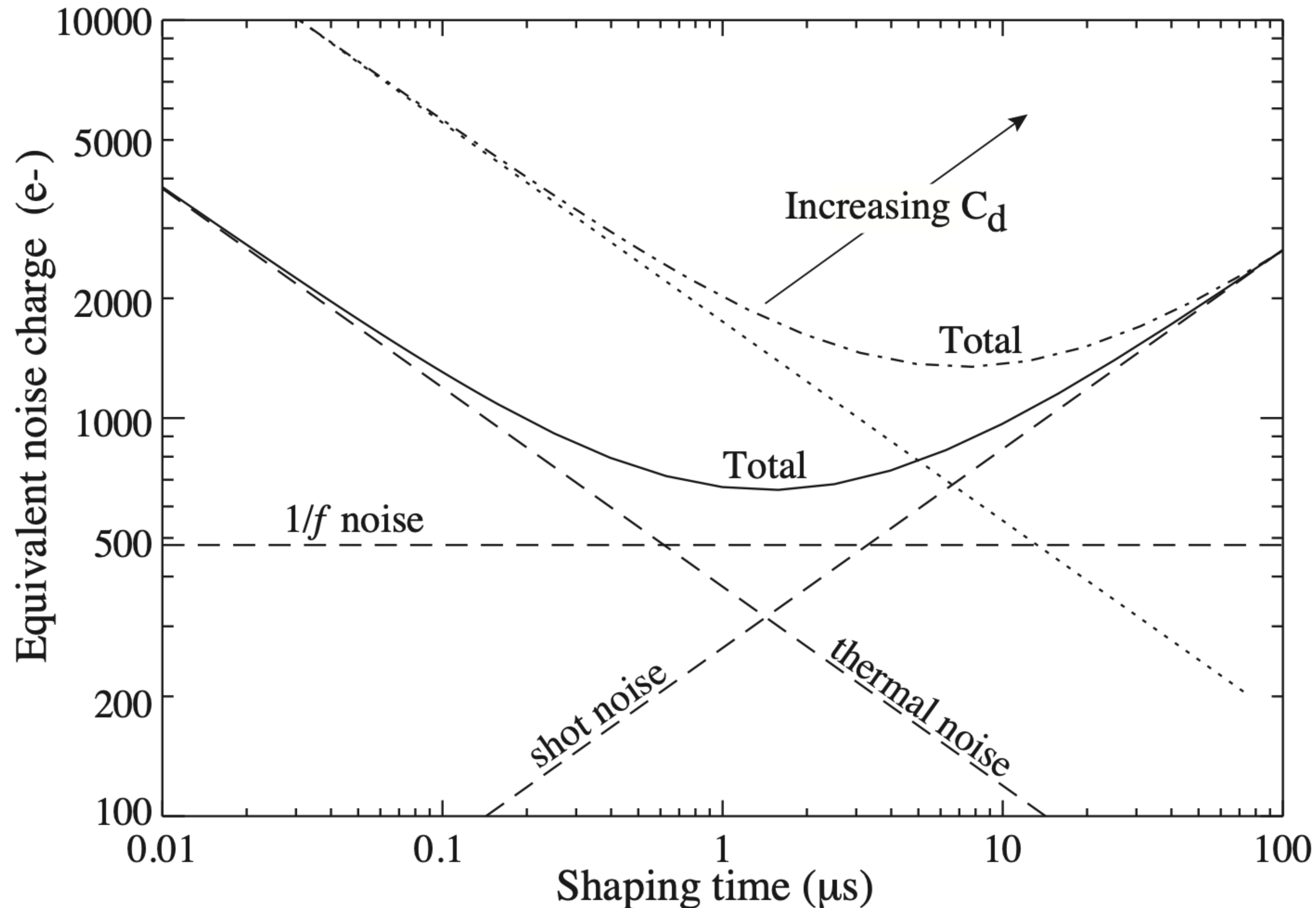
- I_d is circled in red and labeled "leakage current" with a red arrow.
- τ is circled in blue and labeled "shaping time" with a blue arrow.
- C_D^2 is circled in green and labeled "input capacitance" with a green arrow.
- τ is circled in blue and labeled "shaping time" with a blue arrow.

with: $\gamma = 2/3$, $K_f = 33 \times 10^{-25} \text{ J}$, and $C'_{ox} = 6 \text{ fF}/\mu\text{m}^2$

from: R.L. Workman et al. (Particle Data Group), Prog. Theor. Exp. Phys. 2022, 083C01 (2022)

Optimal Filters

Selecting the right shaping time



- shaping time can be optimized to obtain the smallest possible ENC for a given combination of noise contributions.

35.9.2.0.1 Examples Using (35.36) one finds for a typical pixel detector (before heavy irradiation) with $C_D = 200 \text{ fF}$, $I_d = 1 \text{ nA}$, $\tau = 50 \text{ ns}$, $W = 20 \text{ }\mu\text{m}$, $L = 0.5 \text{ }\mu\text{m}$, $g_m = 0.5 \text{ mS}$:

$$\text{ENC}^2 \approx (24 e^-)^2 \Big|_{\text{shot}} + (17 e^-)^2 \Big|_{1/f} + (25 e^-)^2 \Big|_{\text{therm}} \approx (40 e^-)^2.$$

For a typical silicon microstrip detector after radiation damage (fluence $\gtrsim 10^{14} \text{ n}_{\text{eq}}/\text{cm}^2$, assuming no degradation of the front-end electronics due to radiation) one obtains for $C_D = 20 \text{ pF}$, $I_d = 1 \text{ }\mu\text{A}$, $\tau = 50 \text{ ns}$, $W = 2000 \text{ }\mu\text{m}$, $L = 0.4 \text{ }\mu\text{m}$, $g_m = 5 \text{ mS}$:

$$\text{ENC}^2 \approx (750 e^-)^2 \Big|_{\text{shot}} + (200 e^-)^2 \Big|_{1/f} + (800 e^-)^2 \Big|_{\text{therm}} \approx (1100 e^-)^2.$$

Apart from the larger leakage current, the larger capacitance of strips compared to pixels leads to a much worse noise performance which can only be partially compensated by allowing more power in the amplification transistor, *i.e.*, by increasing g_m .

A liquid argon calorimeter cell is a suitable example of a detector with a large electrode capacitance with typical parameters (similar to the ATLAS central electromagnetic calorimeter, see Sec. 35.10). Using $C_D = 1.5 \text{ nF}$, $I_d = < 2 \text{ }\mu\text{A}$, $\tau = 50 \text{ ns}$, $W = 3000 \text{ }\mu\text{m}$, $L = 0.25 \text{ }\mu\text{m}$, $g_m = 100 \text{ mS}$, one obtains:

$$\text{ENC}^2 \approx (1000 e^-)^2 \Big|_{\text{shot}} + (15000 e^-)^2 \Big|_{1/f} + (13500 e^-)^2 \Big|_{\text{therm}} \approx (20200 e^-)^2.$$

Here only a small (negligible) parallel shot noise (leakage current) contribution is assumed, which is typical for liquid argon calorimeters.

aus: N. Wermes in R.L. Workman et al. (Particle Data Group), Prog. Theor. Exp. Phys. 2022, 083C01 (2022)

DONE!

Thank you all for your participation.

**If you are interested in HiWi positions or a thesis on
“technical” topics in physics please get in touch!**

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